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(12) **United States Design Patent**
Laffon de Mazieres et al.

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(54) **EARBUDS CASE**

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(**) Term: **15 Years**

(21) Appl. No.: **29/735,880**

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(51) **LOC (13) Cl.** **03-01**

(52) **U.S. Cl.**
USPC **D3/294**

(58) **Field of Classification Search**
USPC D3/207, 212, 215, 218, 219, 266, 273,
D3/275, 294, 299, 300, 302, 313
CPC H04R 2460/17
See application file for complete search history.

(56) **References Cited**

U.S. PATENT DOCUMENTS

D818,268 S *	5/2018	Akana	D3/294
D826,152 S *	8/2018	Christiansen	D13/108
D826,852 S *	8/2018	Hung	D13/108
D873,217 S *	1/2020	Zhang	D13/108
D878,045 S *	3/2020	Akana	D3/274

OTHER PUBLICATIONS

iLuv TB100 Wireless Earbuds, announced Dec. 19, 2019 [online], [site visited Sep. 20, 2021]. Available from internet, URL: <<https://www.amazon.com/Hands-Free-Microphone-Waterproof-Protection-High-Fidelity/dp/B082XGZ455/?th=1>> (Year: 2019).*

Apple AirPods Pro, announced Oct. 28, 2019 [online], [site visited Sep. 20, 2021]. Available from internet, URL: <<https://www.amazon.com/Apple-MWP22AM-A-AirPods-Pro/dp/B07ZPC9QD4/>> (Year: 2019).*

Indian Office Action dated Dec. 21, 2020 for Indian Patent Application No. 335375-001, a counterpart foreign application of U.S. Appl. No. 29/735,880, 2 pages.

Translated Japanese Office Action dated Feb. 12, 2021 for Japanese patent application No. 2020-025002, a counterpart foreign application of U.S. Appl. No. 29/735,880, 5 pages.

“Wireless Stereo Inside Phone RZ-S50W Product Overview”, retrieved from <<<https://panasonic.jp/headphone/p-db/RZ-S50W.html>>>, 3 pages A design of wireless earphone case (Publicly known design No. RJ02009617 of Japan Patent Office).

Chinese Office Action dated Jun. 8, 2021 for Chinese Patent Application No. 202030718890.6, a counterpart foreign application of U.S. Appl. No. 29/735,880, 1 page.

* cited by examiner

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(57) **CLAIM**

The ornamental design for an earbuds case, as shown and described.

DESCRIPTION

FIG. 1 is a top perspective view of an earbuds case;

FIG. 2 is a front view thereof;

FIG. 3 is a back view thereof;

FIG. 4 is a left-side view thereof;

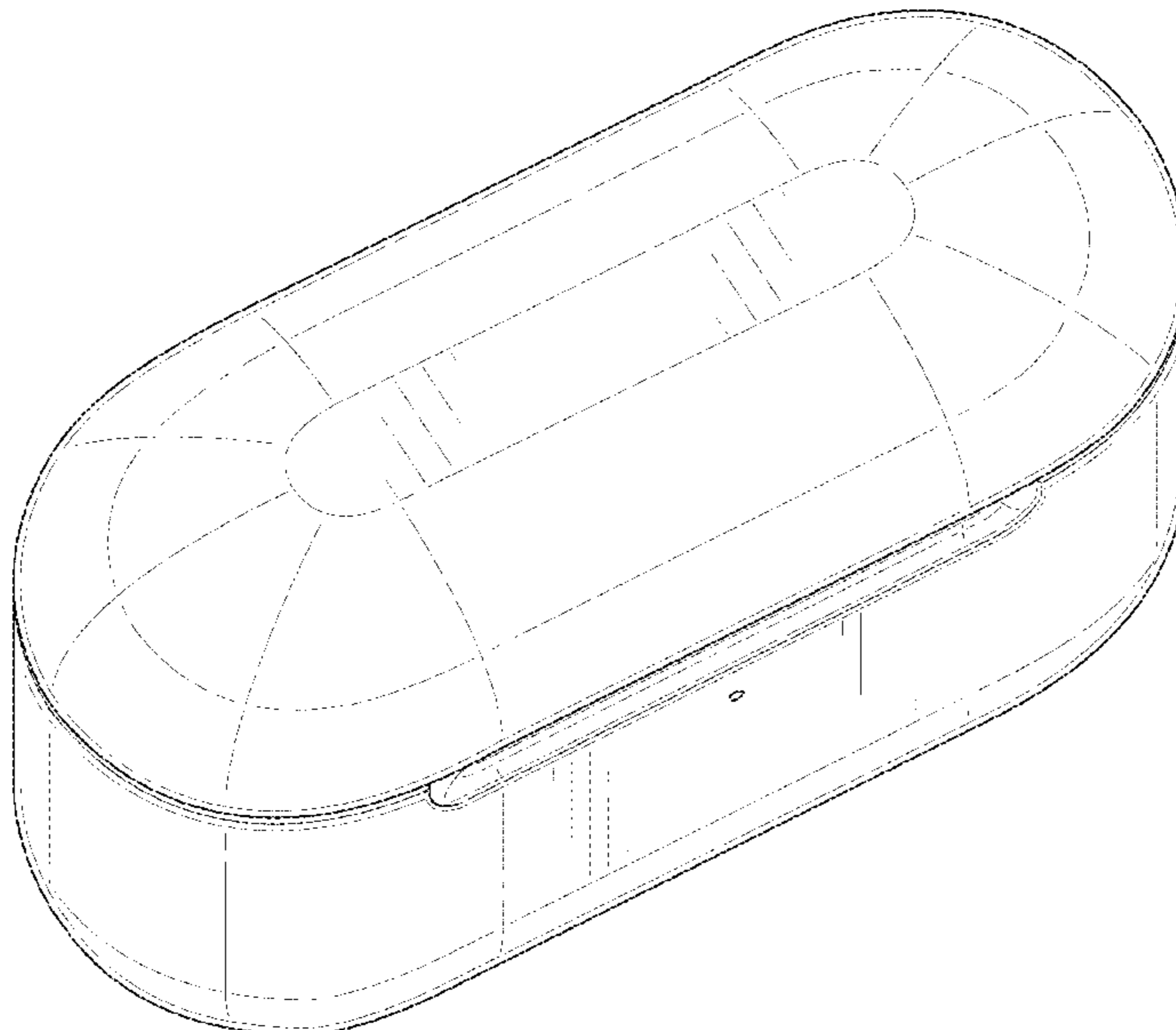
FIG. 5 is a right-side view thereof;

FIG. 6 is a top view thereof; and,

FIG. 7 is a bottom view thereof.

The dashed broken lines depict portions of the earbuds case that form no part of the claimed design.

1 Claim, 7 Drawing Sheets



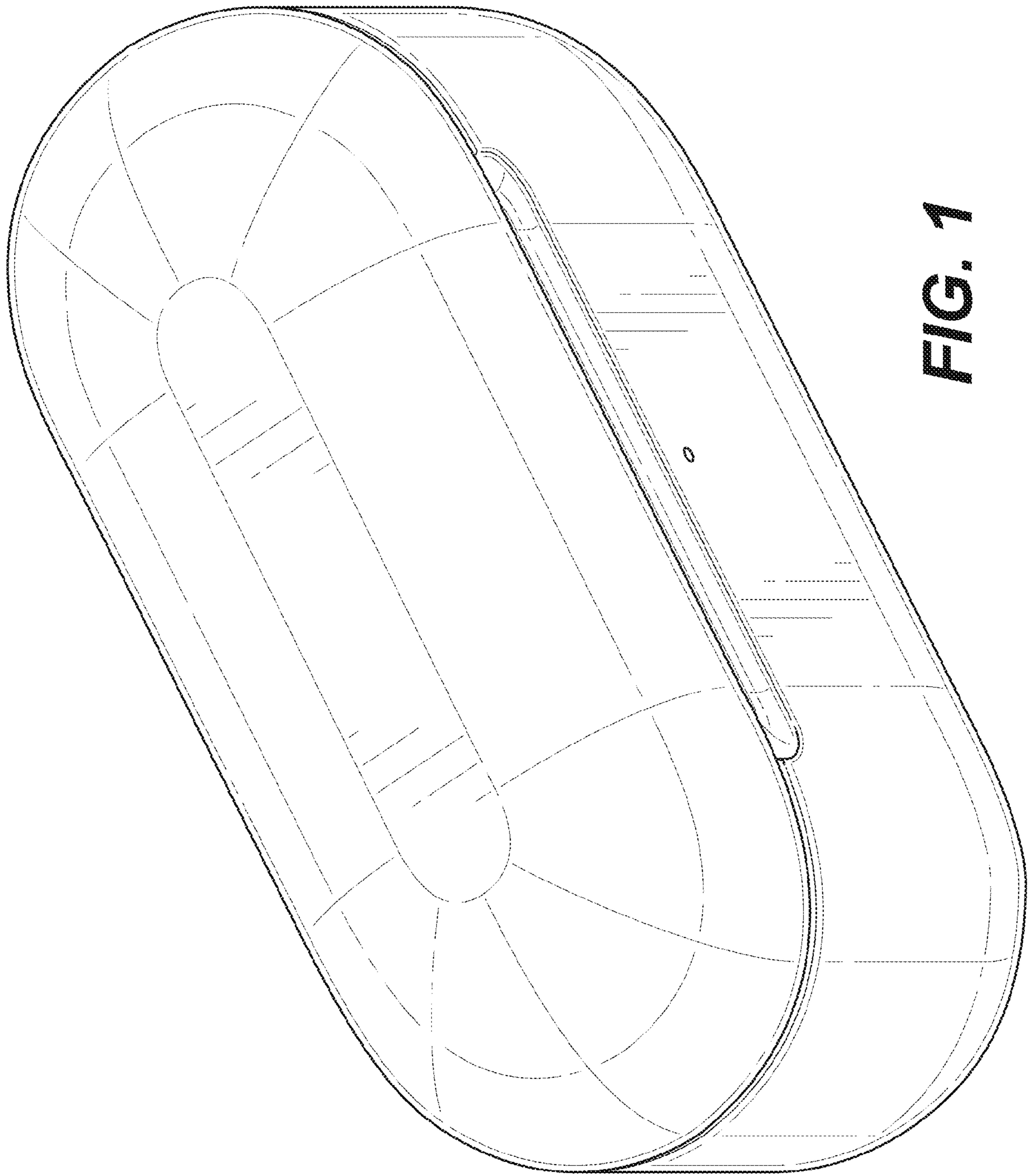


FIG. 1

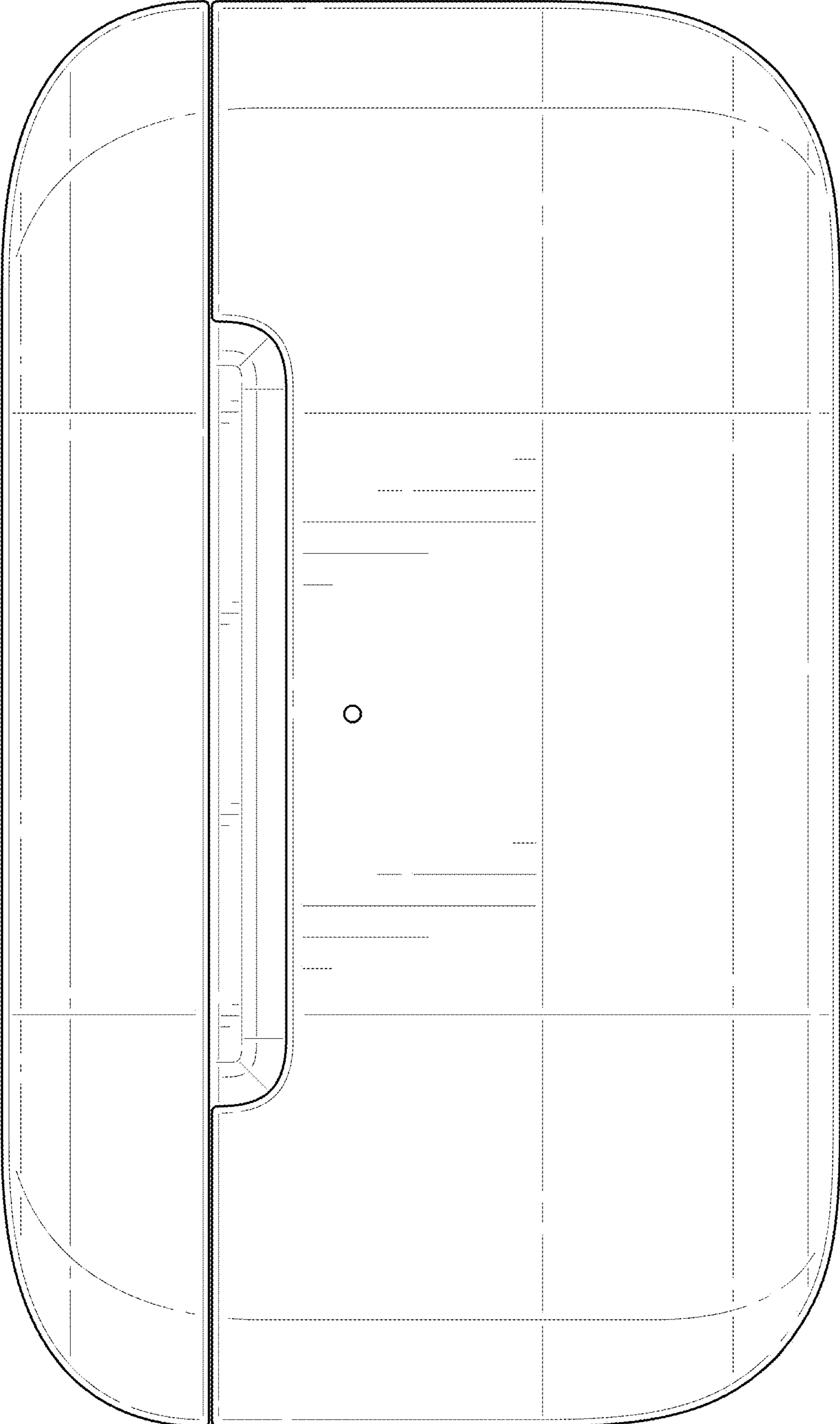


FIG. 2

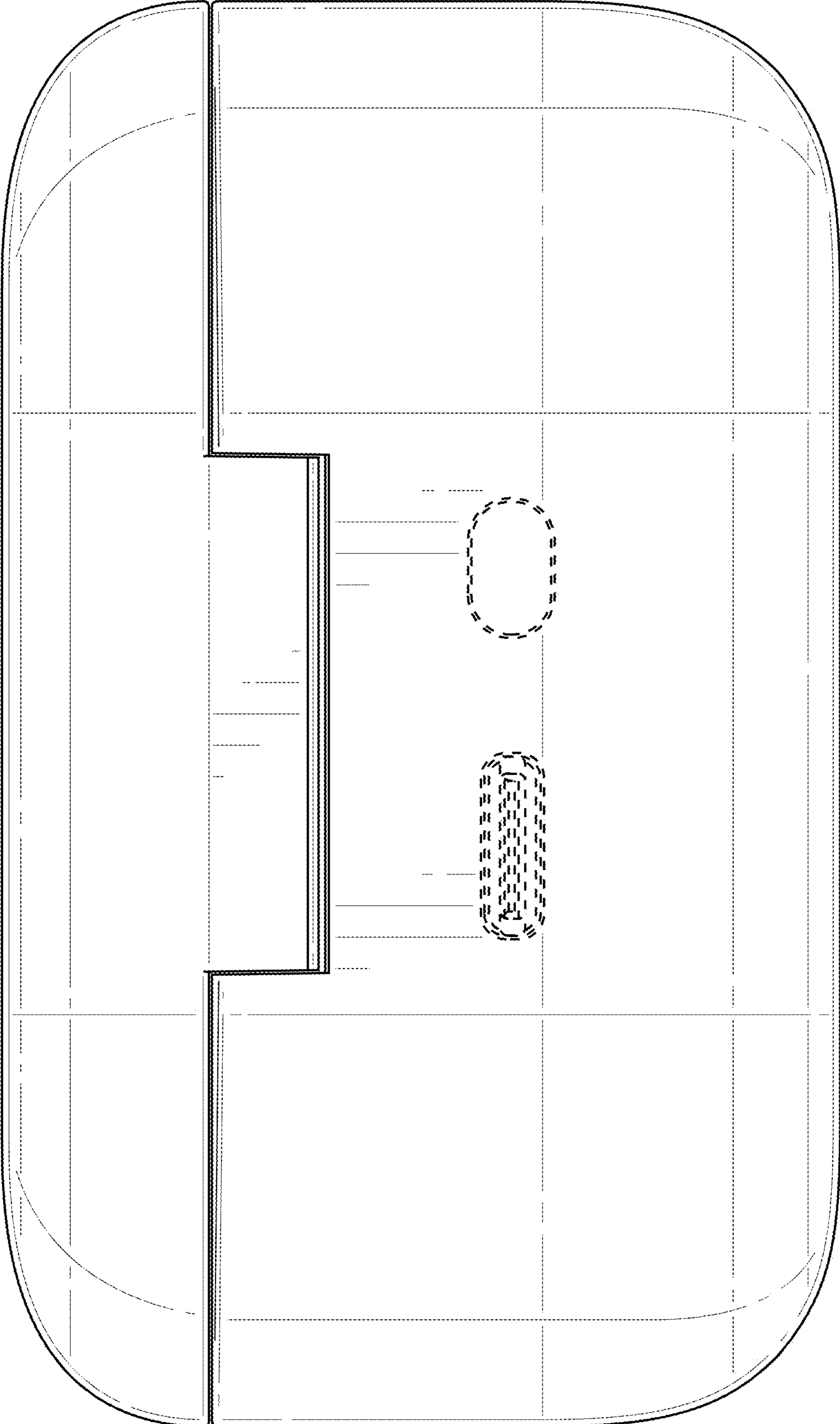


FIG. 3

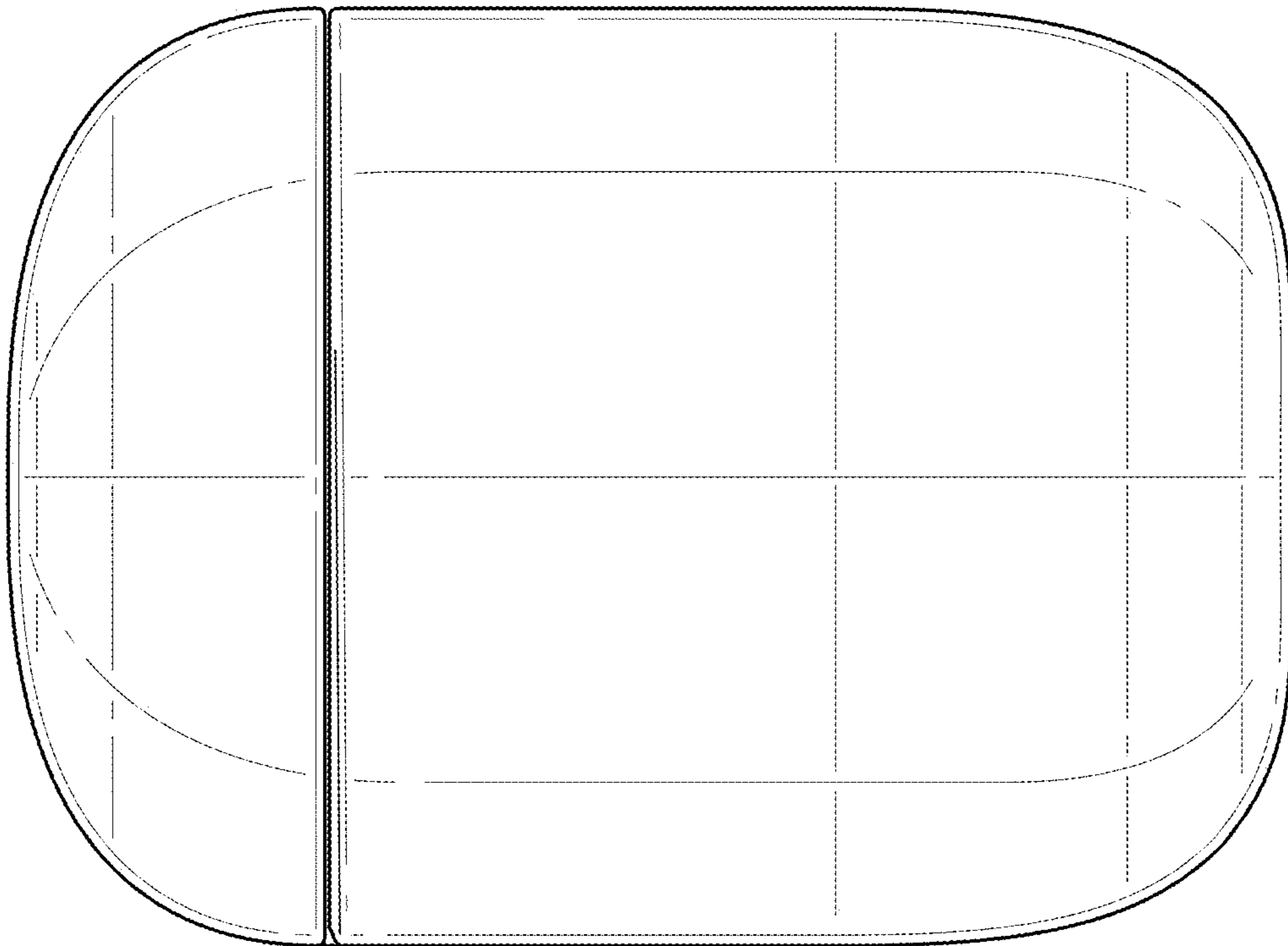


FIG. 4

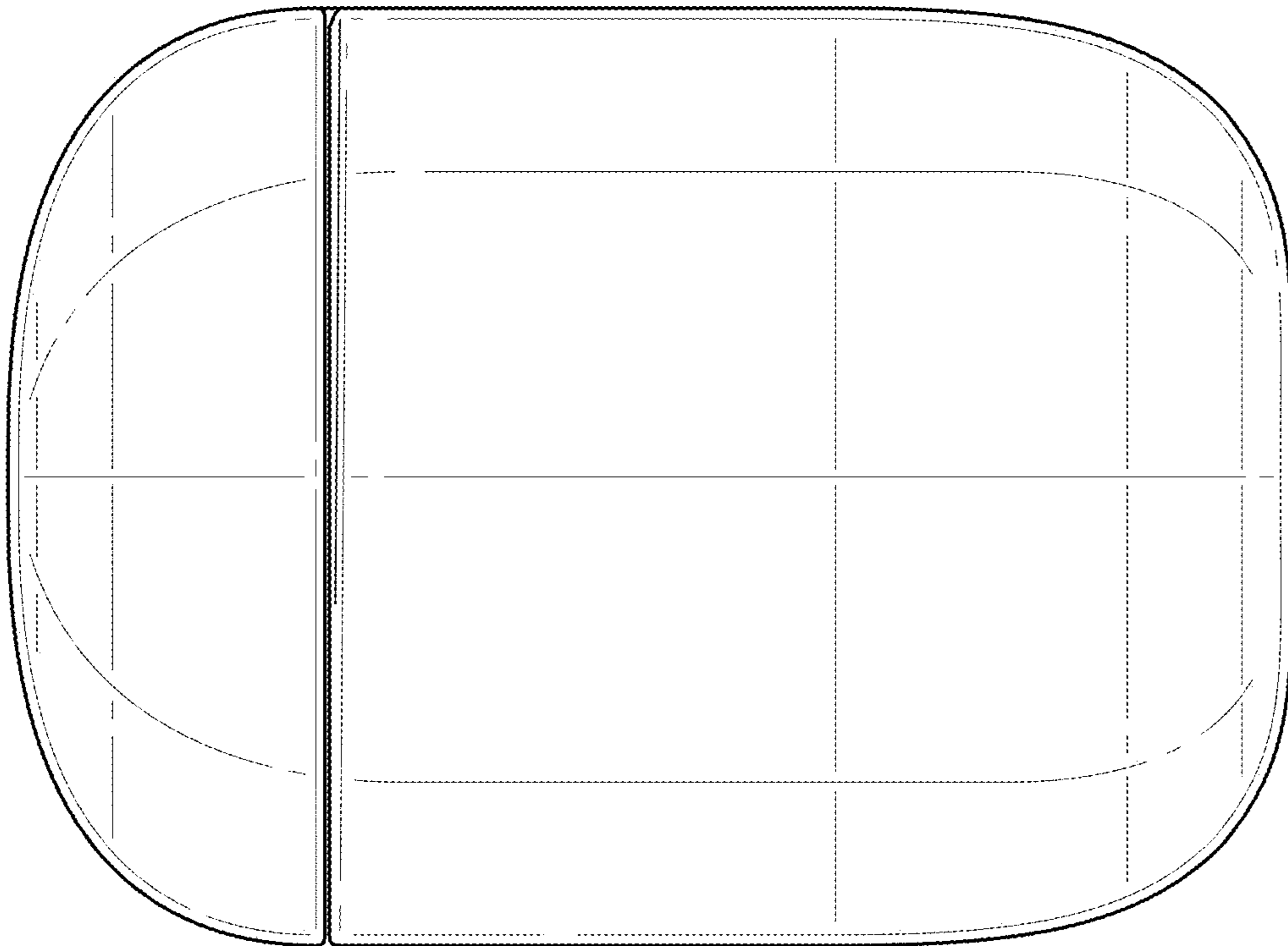


FIG. 5

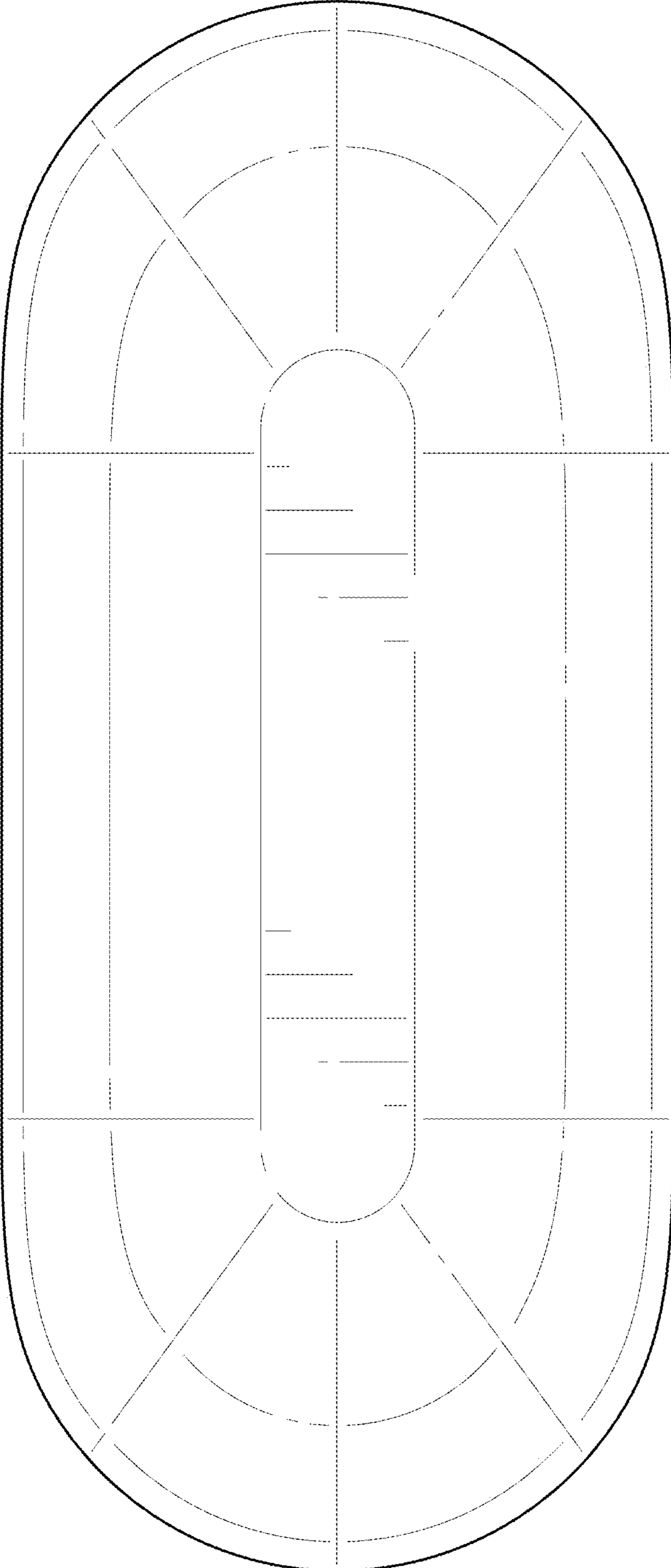


FIG. 6

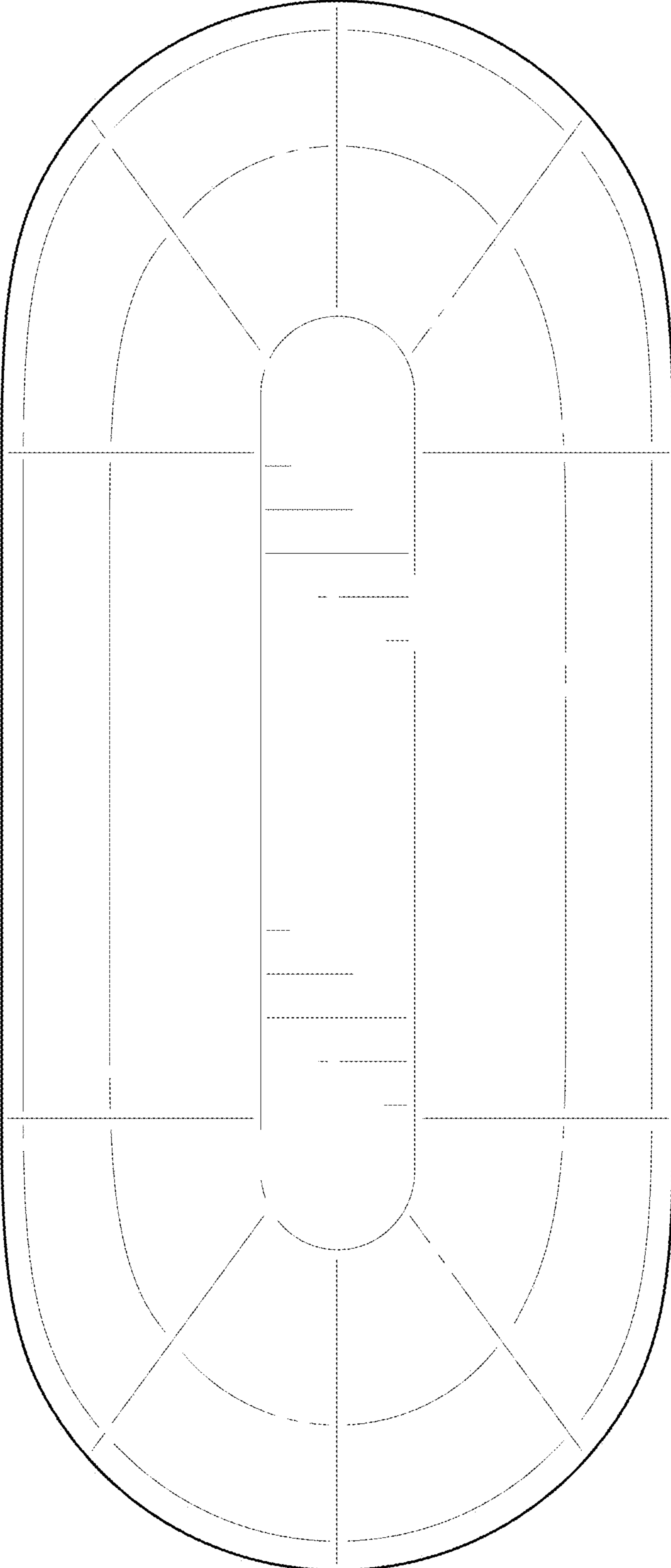


FIG. 7